

A

B

C

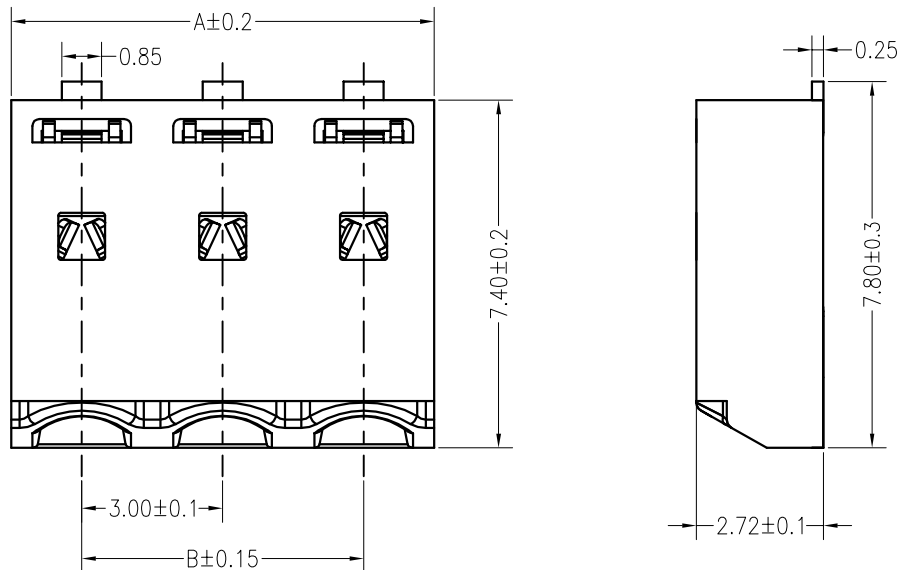
D

E

F

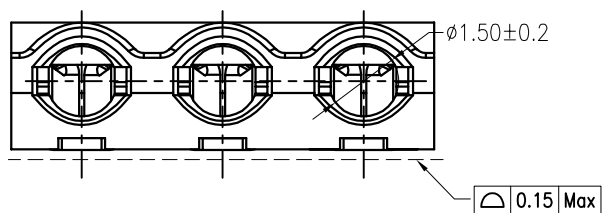
REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	吴丹平	2017.08.31

1



2

3



4

主要技术参数 Main Specifications

线数 (Poles): 01 to 03
 接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
 绝缘电阻 (Insulation resistance): $\geq 800\text{M}\Omega$
 额定电压 (Rated voltage): 275V AC DC
 额定电流 (Rated current): 2.0A AC DC
 耐电压 (Withstand Voltage): 800V AC/minute
 温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +110^{\circ}\text{C}$

编码	DIM A	DIM B
01	3.00	
02	6.00	3.00
03	9.00	6.00



5

A

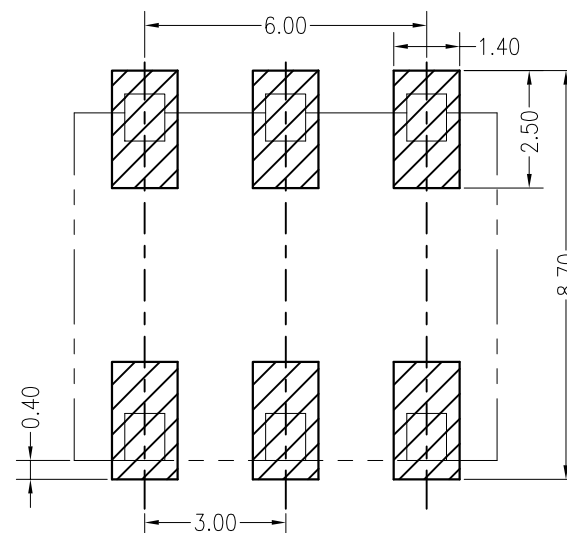
B

C

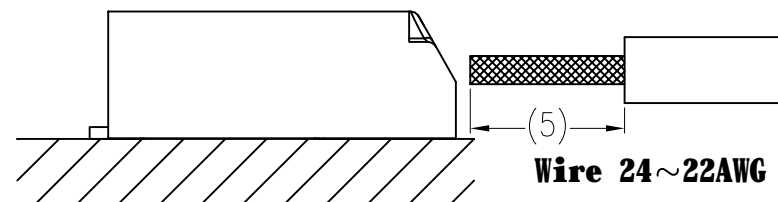
D

E

F



Board Layout



ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
B	CONTACT	1~3 PCS	PhosphorBronze	Matte Sn
A	HOUSING	1~3 PCS	LCP/PA9T	UL 94V-0, COLOR:BEIGE

LEDsconn		TITLE: -	
X.±0.5	X.±5'	USE: CUSTOMER	3.0mmPITCH 90°WAFER SMT TYPE
.X±0.3	.X±2'	APPD:	PART NO.:
.XX±0.25	.XX±1'	CHKD:	DWG NO.:
--	--	DR:	SCALE 1:1
	UNITS: mm		SHEET 1 / 1